

March 1999

FDG6323L Integrated Load Switch

General Description

This device is particularly suited for compact power management in portable electronic equipment where 2.5V to 8V input and 0.6A output current capability are needed. This load switch integrates a small N-Channel power MOSFET (Q1) which drives a large P-Channel power MOSFET (Q2) in one tiny SC70-6 package.

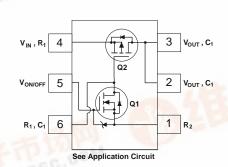
Features

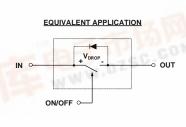
- $\begin{array}{ll} & V_{\text{DROP}} \!\!=\!\! 0.2 V @ V_{\text{IN}} \!\!\!=\!\! 5 \text{V}, \ I_{\text{L}} \!\!\!=\!\! 0.36 \text{A}. \ R_{\text{(ON)}} \!\!\!=\! 0.55 \Omega \\ & V_{\text{DROP}} \!\!\!=\!\! 0.2 V @ V_{\text{IN}} \!\!\!=\!\! 2.5 \text{V}, \ I_{\text{L}} \!\!\!=\!\! 0.27 \text{A}. \ R_{\text{(ON)}} \!\!\!=\! 0.75 \Omega. \end{array}$
- Very small package outline SC70-6.
- Control MOSFET (Q1) includes Zener protection for ESD ruggedness (>6KV Human Body Model).
- High density cell design for extremely low on-resistance.
- Compact industry standard SC70-6 surface mount package.





SC70-6





Absolute Maximum Ratings T_A = 25°C unless otherwise noted

Symbol	Parameter	FDG6323L	Units
V _{IN}	Input Voltage Range	2.5 - 8	V
V _{ON/OFF}	On/Off Voltage Range	1.5 - 8	V
Ĺ.	Load Current - Continuous (Note 1)	0.6	А
	- Pulsed (Note 1 & 3)	1.8	
)	Maximum Power Dissipation (Note 2)	0.3	W
T_J , T_{STG}	Operating and Storage Temperature Range	-55 to 150	°C
ESD	Electrostatic Discharge Rating MIL-STD-883D Human Body Model (100pf/1500Ohm)	6	kV
THERMA	L CHARACTERISTICS		•
R _{e IA}	Thermal Resistance, Junction-to-Ambient (Note 2)	415	°C/W



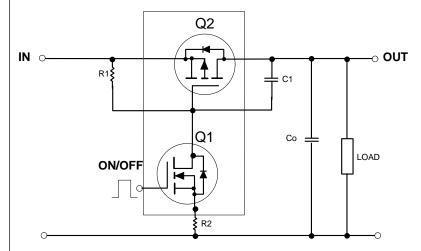
Symbol	Parameter	Min	Тур	Max	Units	
OFF CHA	RACTERISTICS				•	
I _{FL}	Forward Leakage Current	V _{IN} = 8 V, V _{ONOFF} = 0 V			1	μΑ
ON CHAR	ACTERISTICS (Note 3)					
V_{DROP}	Conduction Voltage Drop	$V_{IN} = 5 \text{ V}, \ V_{ON/OFF} = 3.3 \text{ V}, \ I_L = 0.36 \text{ A}$		0.14	0.2	V
		$V_{IN} = 2.5 \text{ V}, \ V_{ON/OFF} = 3.3 \text{ V}, \ I_{L} = 0.27 \text{ A}$		0.15	0.2	
R _(ON)	Q ₂ - Static On-Resistance	$V_{GS} = -5 \text{ V}, I_{D} = -0.6 \text{ A}$		0.41	0.55	Ω
		$V_{GS} = -2.5 \text{ V}, I_D = -0.5 \text{ A}$		0.58	0.75	
I _L	Load Current	$V_{DROP} = 0.2 \text{ V}, V_{IN} = 5 \text{ V}, V_{ON/OFF} = 3.3 \text{ V}$	0.36			Α
		$V_{DROP} = 0.2 \text{ V}, V_{IN} = 2.5 \text{ V}, V_{ONOFF} = 3.3 \text{ V}$	0.27			

Notes:

- 1. Range of V_{in} can be up to 8V, but R_1 and R_2 must be scaled such that V_{GS} of Q2 does not exceed -8V.
- 2. R_{gua} is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. R_{gua} is guaranteed by design while R_{gua} is determined by the user's board design.
- 3. Pulse Test: Pulse Width \leq 300 μ s, Duty Cycle \leq 2.0%

FDG6323L Load Switch Application

APPLICATION CIRCUIT



External Component Recommendation

R1 is required to turn Q2 off. R2 is optional for Slew Rate Control.

For $Co \le 1uF$ applications:

First select R2,100 - 1K Ω , for Slew Rate control.

Then select R1 such that R1/R2 ratio maintains between 10 - 100.

Typical Electrical Characteristics ($T_A = 25$ $^{\circ}C$ unless otherwise noted)

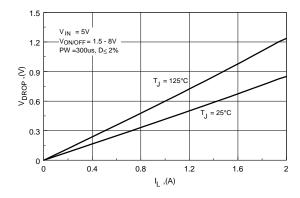


Figure 1. Conduction Voltage Drop Variation with Load Current.

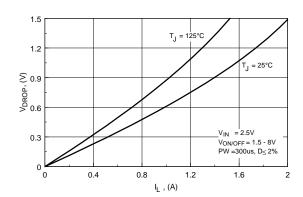


Figure 2. Conduction Voltage Drop Variation with Load Current.

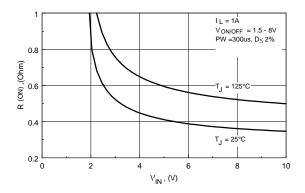


Figure 3. On-Resistance Variation with Input Voltage.

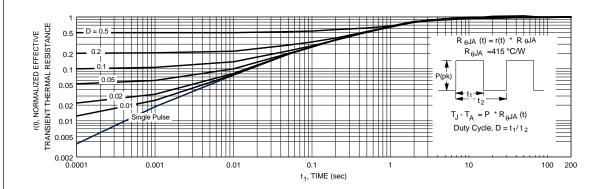


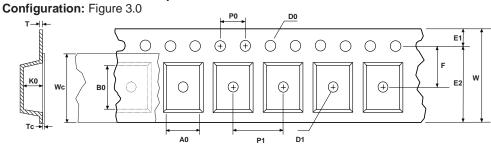
Figure 4. Transient Thermal Response Curve.

Thermal characterization performed using the conditions described in Note 2. Transient thermal response will change depending on the circuit board design.

SC70-6 Tape and Reel Data and Package Dimensions FAIRCHILD SEMICONDUCTOR TM SC70-6 Packaging Configuration: Figure 1.0 Packaging Description: **Customized Label** Packaging Description: SC70-6 parts are shipped in tape. The carrier tape is made from a dissipative (carbon filled) polycarbonate resin. The cover tape is a multilayer film (Heat Activated Adhesive in nature) primarily composed of polyester film, adhesive layer, sealant, and anti-static sprayed agent. These reeled parts in standard option are shipped with 3,000 units per 7" or 177cm diameter reel. The reels are dark blue in color and is made of polystyrene plastic (anti-static coated). Other option comes in 10,000 units per 13" or 330cm diameter reel. This and some other options are described in the Packaging Information table. Antistatic Cover Tape These full reels are individually barcode labeled and Inese full reels are individually barcooe aloeleed and placed inside a pizza box (illustrated in figure 1.0) made of recyclable corrugated brown paper with a Fairchild logo printing. One pizza box contains three reels maximum. And these pizza boxes are placed inside a barcode labeled shipping box which comes in different sizes depending on the number of parts shipped. F63TNR Static Dissipative Label **Embossed Carrier Tape** 10. 11. 10 • 21 SC70-6 Packaging Information Packaging Option D87Z no flow code **SC70-6 Unit Orientation** TNR Packaging type TNR Qtv per Reel/Tube/Bag 10.000 3.000 7" Dia 13" Reel Size Box Dimension (mm) 184x187x47 343x343x64 9,000 30,000 Max qty per Box 343mm x 342mm x 64mm F63TNR Barcode Label Weight per unit (gm) 0.0055 0.0055 Intermediate box for D87Z Option Weight per Reel (kg) 0.1140 0.3960 Note/Comments F63TNR Label F63TNR Label sample 184mm x 187mm x 47mm Label Pizza Box for Standard Option D/C1: D9842 D/C2: QTY1: QTY2: N/F: F (F63TNR)3 SC70-6 Tape Leader and Trailer Configuration: Figure 2.0 0 0 0 0 0 0 0 0 \bigcirc 0 0 \bigcirc \bigcirc \bigcirc 0 0 5-----7 Carrier Tane Components Cover Tape Trailer Tape Leader Tape 300mm minimum or 500mm minimum or 75 empty pockets 125 empty pockets



SC70-6 Embossed Carrier Tape



User Direction of Feed	
	┲

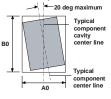
Dimensions are in millimeter														
Pkg type	Α0	В0	w	D0	D1	E1	E2	F	P1	P0	K0	Т	Wc	Тс
SC70-6 (8mm)	2.24 +/-0.10	2.34 +/-0.10	8.0 +/-0.3	1.55 +/-0.05	1.125 +/-0.125	1.75 +/-0.10	6.25 min	3.50 +/-0.05	4.0 +/-0.1	4.0 +/-0.1	1.20 +/-0.10	0.255 +/-0.150	5.2 +/-0.3	0.06 +/-0.02

Notes: A0, B0, and K0 dimensions are determined with respect to the EIA/Jedec RS-481 rotational and lateral movement requirements (see sketches A, B, and C).

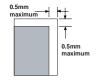


Sketch A (Side or Front Sectional View)
Component Rotation

SC70-6 Reel Configuration: Figure 4.0



Sketch B (Top View)
Component Rotation

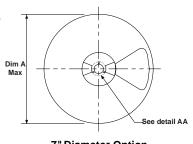


Sketch C (Top View)

Component lateral movement

Dim A max

13" Diameter Option



7" Diameter Option

B Min

Dim D

min

DETAIL AA

Dimensions are in inches and millimeters									
Tape Size	Reel Option	Dim A	Dim B	Dim C	Dim D	Dim N	Dim W1	Dim W2	Dim W3 (LSL-USL)
8mm	7" Dia	7.00 177.8	0.059 1.5	0.512 +0.020/-0.008 13 +0.5/-0.2	0.795 20.2	2.165 55	0.331 +0.059/-0.000 8.4 +1.5/0	0.567 14.4	0.311 - 0.429 7.9 - 10.9
8mm	13" Dia	13.00 330	0.059 1.5	0.512 +0.020/-0.008 13 +0.5/-0.2	0.795 20.2	4.00 100	0.331 +0.059/-0.000 8.4 +1.5/0	0.567 14.4	0.311 - 0.429 7.9 - 10.9

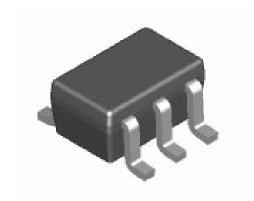
W2 max Measured at Hub

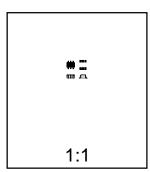
₩3

See detail AA

SC70-6 Tape and Reel Data and Package Dimensions, continued

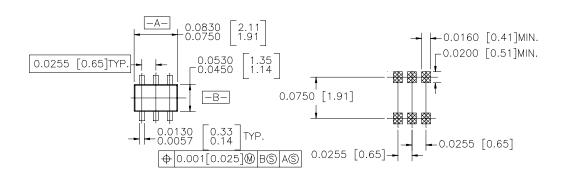
SC70-6 (FS PKG Code 76)



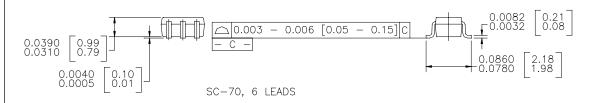


Scale 1:1 on letter size paper
Dimensions shown below are in:
inches [millimeters]

Part Weight per unit (gram): 0.0055



LAND PATTERN RECOMMENDATION



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FACT™ QFET™ FACT Quiet Series™ QS™

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